

2181

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants: KONDO et al  
Serial No: 10/061,435  
Filing Date: January 31, 2002  
For: "System Recovery from Errors for Processor and Associated Components"

Docket No: 20206-123(P99-2890)  
Group Art Unit: 2181  
Examiner: N/A



Commissioner for Patents  
Washington, D.C. 20231

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JUL 01 2002

Technology Center 2100

- ☒ Transmitted herewith are the following documents:
- ☒ Letter for Application Data Sheet (1 page);
  - ☒ Application Data Sheet (2 pages);
  - ☒ Postcard for date-stamped return as confirmation of receipt of these materials.
- ☒ The Commissioner is authorized to charge any required fees, or credit any overpayment to Deposit Account No. 02-3964.

Date: June 18, 2002

Leah Sherry  
Reg. No. 43,918

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CERTIFICATE OF MAILING under 37 CFR 1.8

I hereby certify that this paper along with any papers referred to as being attached or enclosed is being deposited with the U.S. Postal Service as first class mail in an envelope addressed to: Commissioner for Patents, Washington, D.C., 20231.

Date: June 18, 2002

  
Donna B. Rose

IN THE UNITED STATES PATENT & TRADEMARK OFFICE

COPY OF PAPERS  
ORIGINALLY FILED

Applicant(s): KONDO et al.

Application No.: 10/061,431

Filing Date: January 31, 2002

For: "System Recovery from Errors for  
Processor and Associated Components"

Examiner: N/A

Art Unit: 2181

Docket No.: 20206-123 (P99-2890)

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By: Donna B. Rose  
Donna B. Rose

Date: June 18, 2002

Commissioner for Patents  
Washington, DC 20231

LETTER FOR APPLICATION DATA SHEET

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JUL 01 2002  
Technology Center 2100

Sir:

The enclosed Application Data Sheet is being submitted for the above-identified application in order to update the U.S. Patent Office records with the residence address for inventor, William P. Bunton. Mr. Bunton's address has changed from his residence address listed on the Declaration and Power of Attorney to the residence address listed on the enclosed Application Data Sheet. No other inventor has changed their residence address.

The Applicants respectfully request the U.S. Patent Office to enter the information contained on the Application Data Sheet to bring current the inventor's address for the pending application.

Respectfully submitted,

Dated: June 18, 2002  
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